# 1775099-8 ✓ ACTIVE

#### **ATX Power**

TE Internal #: 1775099-8

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 1.4 mm [. 055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray,

ATX Power

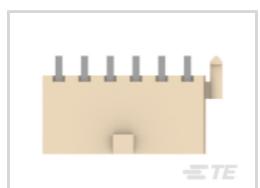
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

Connector System: Wire-to-Board

Number of Positions: 12

Number of Rows: 2

Centerline (Pitch): 1.4 mm [ .055 in ]

### **Features**

### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	12
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC
Body Features	
Primary Product Color	lvory

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**Contact Features** 



PCB Contact Termination Area Plating Material Thickness	3.05 µm[120.07 µin]
Contact Layout	Matrix
Mating Tab Width	1.14 mm[.044 in]
Mating Tab Thickness	1.1 mm[.043 in]
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	3.05 μm[120.07 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	9 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.55 mm[.021 in]
Rectangular Termination Post & Tail Width	1.14 mm[.044 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	Without
Mating Retention  Connector Mounting Type	Without  Board Mount
Connector Mounting Type	Board Mount
Connector Mounting Type  Mating Alignment	Board Mount With
Connector Mounting Type  Mating Alignment  PCB Mount Alignment	Board Mount With Without
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention	Board Mount With Without
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention  Housing Features	Board Mount With Without With
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention  Housing Features  Housing Material	Board Mount With Without With
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)	Board Mount With Without With
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Dimensions	Board Mount With Without With  PA 9T  1.4 mm[.055 in]
Connector Mounting Type  Mating Alignment  PCB Mount Alignment  PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Dimensions  Row-to-Row Spacing	Board Mount With Without With  PA 9T  1.4 mm[.055 in]



Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tray

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

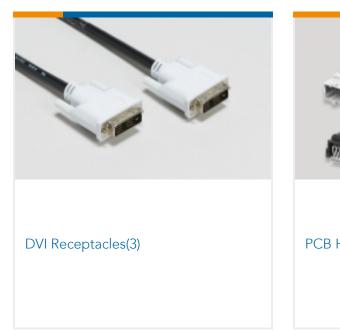
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



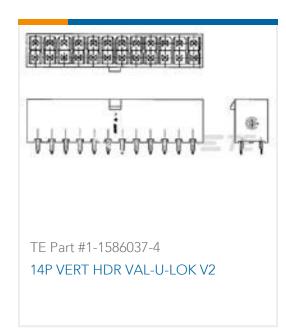


# Also in the Series | ATX Power





# Customers Also Bought









TE Part #471555-E VORCSI ENTRIEGELUNGSWERKZ. CSI-KONT. J 3

### **Documents**

#### **CAD Files**

3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_1775099-8\_E.2d\_dxf.zip

English

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 1.4 mm [.055 in] Centerline, Tin, Through Hole - Solder, Power, Ivory, Tray, ATX Power



**Customer View Model** 

ENG\_CVM\_CVM\_1775099-8\_E.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1775099-8\_E.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Product Specification** 

English

**Product Specification** 

English